

## SILICON P-N-P HIGH-VOLTAGE TRANSISTORS

P-N-P high-voltage small-signal transistors, primarily intended for use in telephony applications and encapsulated in a TO-92 package.

## QUICK REFERENCE DATA

		PH5415	PH5416
Collector-base voltage (open emitter)	$-V_{CBO}$	max. 200	350 V
Collector-emitter voltage (open base)	$-V_{CEO}$	max. 200	300 V
Collector current	$-I_C$	max. 1,0	1,0 A
Total power dissipation up to $T_{amb} = 25^\circ\text{C}$	$P_{tot}$	max. 500	500 mW
Junction temperature	$T_j$	max. 150	150 $^\circ\text{C}$
Collector-emitter saturation voltage $-I_C = 50 \text{ mA}; -I_B = 5 \text{ mA}$	$-V_{CEsat}$	< 0.8	0.8 V
D.C. current gain $-I_C = 50 \text{ mA}; -V_{CE} = 10 \text{ V}$	$h_{FE}$	> 30 < 150	30 120

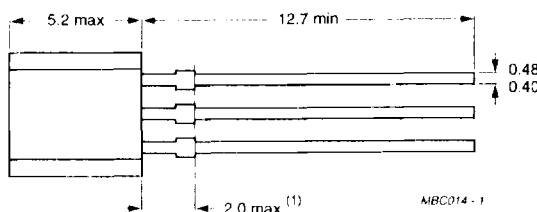
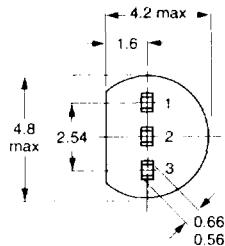
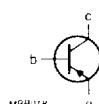
## MECHANICAL DATA

Dimension in mm

Fig. 1 TO-92.

## Pinning

- 1 = emitter  
2 = base  
3 = collector



Note (1) Terminal dimensions within this zone are uncontrolled to allow for plastic and terminal irregularities.

## RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

			PH5415	PH5416	
Collector-base voltage (open emitter)	-V <sub>CBO</sub>	max.	200	350	V
Collector-emitter voltage (open base)	-V <sub>CEO</sub>	max.	200	300	V
Emitter-base voltage (open collector)	-V <sub>EBO</sub>	max.	4,0	6,0	V
Collector current (d.c.)	I <sub>C</sub>	max.	1,0		A
Base current	-I <sub>B</sub>	max.	0,5		A
Total power dissipation up to T <sub>amb</sub> = 25 °C	P <sub>tot</sub>	max.	500		mW
Junction temperature	T <sub>j</sub>	max.	150		°C
Storage temperature range	T <sub>stg</sub>		-65 to 150		°C

## THERMAL RESISTANCE

From junction to ambient in free air	R <sub>th(ja)</sub>	-	250	K/W
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## CHARACTERISTICS

T<sub>j</sub> = 25 °C unless otherwise specified

			PH5415	PH5416	
Collector cut-off currents					
I <sub>E</sub> = 0; -V <sub>CB</sub> = 175 V	-I <sub>CBO</sub>	-	0,1		μA
I <sub>E</sub> = 0; -V <sub>CB</sub> = 280 V	-I <sub>CBO</sub>	-	0,1		μA
I <sub>B</sub> = 0; -V <sub>CE</sub> = 150 V	-I <sub>CEO</sub>	<	1,0		μA
I <sub>B</sub> = 0; -V <sub>CE</sub> = 250 V	-I <sub>CEO</sub>	-	1,0		μA
Emitter cut-off current					
I <sub>C</sub> = 0; -V <sub>EB</sub> = 4 V	-I <sub>EBO</sub>	<	1,0		μA
I <sub>C</sub> = 0; -V <sub>EB</sub> = 6 V	-I <sub>EBO</sub>	<	1,0		μA
Collector-emitter sustaining voltage					
I <sub>B</sub> = 0; I <sub>C</sub> = 50 mA	-V <sub>CEO</sub> sust	>	200	300	V
Saturation voltages					
-I <sub>C</sub> = 50 mA; I <sub>B</sub> = 5 mA	-V <sub>CESat</sub>	<	0,8	0,8	V
-V <sub>BEsat</sub>	-V <sub>BEsat</sub>	<	1,0	1,0	V
D.C. current gain					
-I <sub>C</sub> = 50 mA; -V <sub>CE</sub> = 10 V	h <sub>FE</sub>	>	30	30	
		-	150	120	
Transition frequency at f = 5 MHz					
-I <sub>C</sub> = 10 mA; -V <sub>CE</sub> = 10 V; T <sub>amb</sub> = 25 °C	f <sub>T</sub>	-		15	MHz
Small-signal current gain at f = 5 MHz					
I <sub>C</sub> = 10 mA; -V <sub>CE</sub> = 10 V; T <sub>amb</sub> = 25 °C	h <sub>fe</sub>	>		25	
Real part (Re) of input impedance (h <sub>ie</sub> )					
V <sub>CE</sub> = 10 V; -I <sub>C</sub> = 5 mA; f = 1 MHz; T <sub>amb</sub> = 25 °C	Re(h <sub>ie</sub> )	<	300		Ω
Input capacitance at f = 1 MHz					
I <sub>C</sub> = 0; -V <sub>FB</sub> = 5 V; T <sub>amb</sub> = 25 °C	C <sub>e</sub>	-		75	pF
Output capacitance at f = 1 MHz					
I <sub>E</sub> = 0; -V <sub>CB</sub> = 10 V; T <sub>amb</sub> = 25 °C	C <sub>c</sub>	-		15	pF